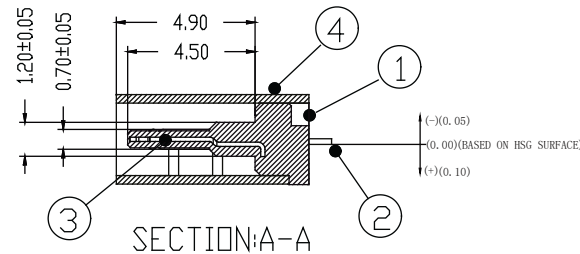
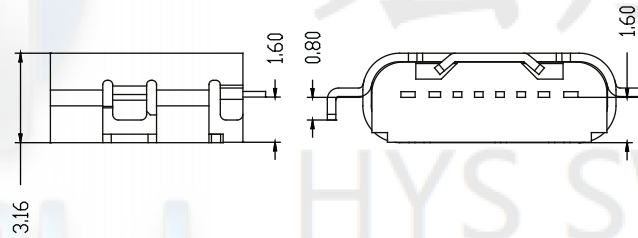
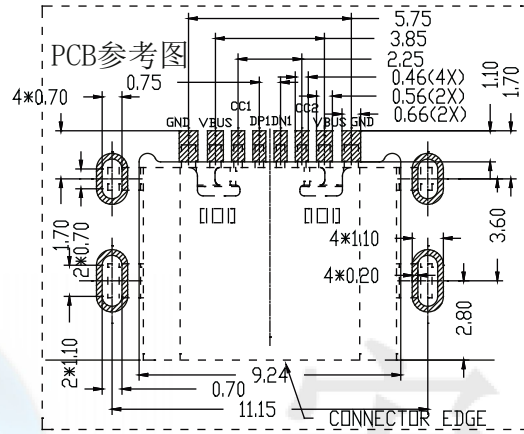
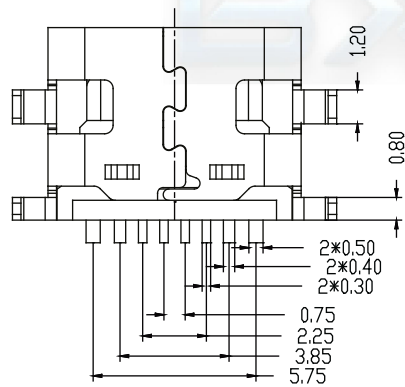
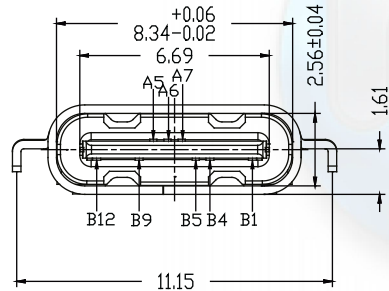
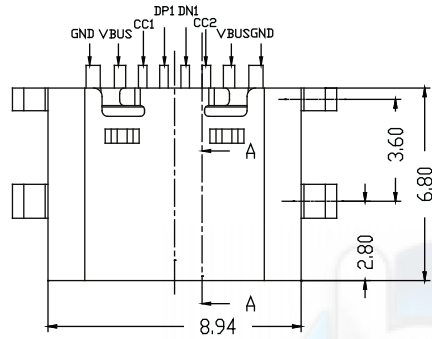


ROHS
Compatible



NOTE:

- 1.MATERIAL SPECIFICATION:
 - 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
 - 2.CONTACTS: COPPER ALLOY
 - 3.MID PLATE: STAINLESS STEEL
 - 4.FRONT SHELL: STAINLESS STEEL
- 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
Ni 50u" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
(GOLD PLATING THICKNESS FOLLOW THE P/N)
PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N
- 3.MECHANICAL PERFORMANCE,
 - 3-1.INSERTION FORCE: 0.5~2.0kgf.
 - 3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.
 - 3-3.DURABILITY: 10000 CYCLES.
- 4.ELECTRICAL PERFORMANCE,
 - 4-1. CURRENT RATING: 3.0A
VOLTAGE RATING: 5.0V
 - 4-2. LLCR:
VBUS & GND PINS AND OTHER PINS: 40mA/PIN MAX.
SHIELD: 50mA/MAX.
LLCR MAX. CHANGE OF ALL PINS: 10m*
 - 4-3.INSULATION RESISTANCE: 100M* MIN
 - 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
5. ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -25-C~+85-C.
- 6.IR REFLOW:
THE PEAK TEMPERATURE ON THE BOARD SHALL
BE MAINTAINED FOR 10 SECONDS AT 260°C.

U5 467- 08P x 1.6C 6.8L
名称 流水号 PIN位 N:母座 C:沉板 L:长度

USB TYPE-C PIN ASSIGNMENTS											
A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12
				CC1	DP1	DN1					
GND				VBUS			CC2	VBUS			GND
B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1

DESIGN	Li Jinwei	SCALL	
DRAWING	Wu Qifa	UNIT	mm
CHECK	Zheng Jinxian	SIZE	A4: 210 * 297
APPROVAL	Liu Xiaohong	DATE	2020-06-10

TOLERANCE	
X.X ±0.30	X.°±2°
.XX ±0.20	.X°±1°
.XXX ±0.10	.XX°±0.5°

DRAWG NO.	U5467-08PN1.6C6.8L
TITLE:	8P 四脚插板SMT 沉板1.6mm 6.8L



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